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H8/38076R

Transition to the Watch Mode

Introduction

In this example a transition is made from the active (high-speed) mode to the watch mode, one of the power-down modes of the H8/38076R.

Target Device

H8/38076R

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1. Specifications

After a reset is cleared the H8/38076R can transition to any of seven power-down modes, in which power consumption is reduced substantially, in addition to the normal active (high-speed) mode. In this sample task a transition is made from the active (high-speed) mode to the watch mode, one of the power-down modes.

2. Description of Functions

2.1 Functions Used

In this sample task a transition is made from the active (high-speed) mode to the watch mode, one of the power-down modes.

The state of the H8/38076R in the watch mode is shown in table 1, and the functions used as described below.

- System Clock (φ)
 This 10-MHz oscillation clock is a reference clock for operation of the CPU and peripheral functions.
- Subclock (φ_W)
 This 32.768-kHz oscillation clock is a reference clock for operation of the CPU and peripheral functions.
- 3. Power-Down Mode (Watch Mode) Function

In the watch mode the system clock oscillator (when the WDT disables the internal oscillator) and CPU operation stop, and the internal peripheral modules stop functioning, except for the RTC (realtime clock), timer F, AEC (asynchronous event counter), and LCD controller/driver. However, as long as the rated voltage is supplied, the contents of CPU registers, some internal peripheral module registers, and internal RAM are retained. The I/O ports retain their state before the transition.

The watch mode is cleared by an interrupt. The watch mode is cleared and interrupt exception handling starts when an interrupt is requested. After the watch mode is cleared by an interrupt a transition is made to the active (high-speed) mode, the active (medium-speed) mode, or the subactive mode, depending on the settings of the LSON bit in SYSCR1 and the MSON bit in SYSCR2. When a transition is made to the active mode, interrupt exception handling starts after the time set in bits STS2 to STS0 in SYSCR1 has elapsed. The watch mode is not cleared if the I bit in CCR is set to 1 or the requested interrupt is disabled by an interrupt enable register.

When the \overline{RES} signal goes low in the watch mode, the system clock oscillator starts. Since system clock signals are supplied to the entire H8/38076R as soon as the system clock oscillator starts functioning, the \overline{RES} signal must be kept low until the system clock oscillator output stabilizes. After the oscillation stabilization time has elapsed the CPU starts reset exception handling if the \overline{RES} signal is driven high.

- System control register 1 (SYSCR1)

 Together with SYSCR2, SYSCR1 controls the power-down modes.
- System control register 2 (SYSCR2)
 Together with SYSCR1, SYSCR2 controls the power-down modes.



Table 1 State of the H8/38076R in the Watch Mode

Function		Watch Mode
System clock oscillator		Halted
Subclock oscillator		Functioning
CPU	Instructions	Halted
	RAM	Retained
	Registers	Retained
	I/O	Retained
External interrupts	IRQ0	Functioning
	IRQ1	Retained ^{*1}
	IRQ3	Retained ^{*1}
	IRQ4	Retained ^{*1}
	IRQAEC	Retained ^{*1}
	WKP0 toWKP7	Functioning
Peripheral modules	Timer F	Functioning/Retained ^{*2}
	AEC (Asynchronous event counter)	Functioning ^{*3}
	RTC (realtime clock)	Functioning/Retained ^{*4}
	TPU (timer pulse unit)	Retained
	WDT (watchdog timer)	Functioning*5/Retained
	SCI3/IrDA module	Reset
	I ² C2 module	Retained
	PWM module	Retained
	A/D converter	Retained
	LCD controller/driver	Functioning/Retained ^{*6}

Notes: 1. External interrupt requests are ignored. The contents of the interrupt request register are not affected.

- 2. Functioning if $\phi_W/4$ is selected as an internal clock. Halted and retained otherwise.
- 3. The counter can be incremented.
- 4. Functioning if the clock time-base function is selected and retained if the interval timer is selected.
- 5. Functioning only if the internal oscillator is selected.
- 6. Functioning if ϕ_W , $\phi_W/2$, $\sigma\phi_W/4$ is selected as the clock to be used. Halted and retained otherwise.

2.2 Assignment of Functions

Table 2 shows the assignment of functions in this sample task. A transition is made from the active (high-speed) mode to the watch mode, one of the power-down modes, using functions assigned as shown in table 2.

Table 2 Assignment of Functions

Elements	Description	
SYSCR1	Together with SYSCR2, controls transition to the watch mode	
SYSCR2	Together with SYSCR1, controls transition to the watch mode	



3. Principles of Operation

The principles of operation of this sample task are described below. Using the procedure shown, a transition is made from the active (high-speed) mode to the watch mode, one of the power-down modes. The mode transitions in this sample task are illustrated in figure 1.

- 1. Transition to the watch mode
 - a. Set the SSBY and TMA3 bits in SYSCR1 to 1.
 - b. Clear the DTON bit in SYSCR2 to 0.
 - c. Execute the SLEEP instruction.
- 2. Clearing the watch mode
 - a. Receive an IRQ0, AEC, or WKP7 to WKP0 interrupt in the watch mode.
 - b. Perform interrupt handling. (The recovery destination of the interrupt will be the active mode or subactive mode.)

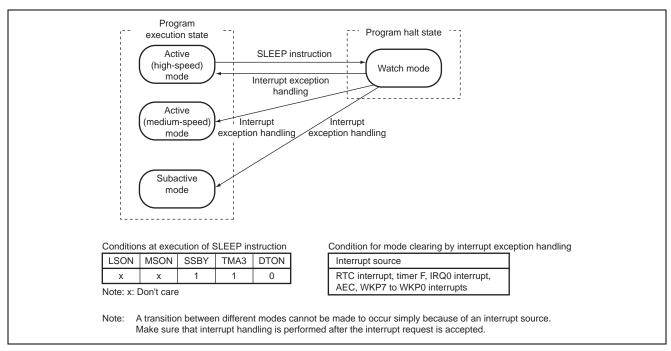


Figure 1 Mode Transition Diagram



4. Internal Registers Used

The internal registers used in this sample task are shown below. The set values shown are those used in the sample task and differ from the initial values.

• SYSCR1 System control register 1 Address: H'FFF0

Bit	Bit Name	Set Value	R/W	Description
7	SSBY	1	R/W	Software standby Selects the mode to transition to after execution of the SLEEP instruction.
				0: A transition is made to the sleep mode or the subsleep mode
				A transition is made to the standby mode or the watch mode
6	STS2	User defined	R/W	Standby timer selection 2 to 0
5	STS1	User defined	R/W	Specifies the number of wait states that must elapse after
4	STS0	User defined	R/W	the system clock oscillator begins functioning until the clock is supplied when transitioning from the standby mode, the subactive mode, the subsleep mode, or the watch mode to the active mode or the sleep mode. The relationship between the specified value and the number of wait states is shown in table 3. The minimum value (STS2 = 1, STS1 = 0, STS0 = 1) is recommended if an external clock is used. If a setting other than the recommended value is used, operation may start before the end of the waiting time.
3	LSON	User defined	R/W	Selects the system clock (φ) or subclock (φ _{SUB}) as the CPU operating clock when the watch mode is cleared. 0: The CPU operates on the system clock (φ) 1: The CPU operates on the subclock (φ _{SUB})
2	TMA3	1	R/W	In combination with bits SSBY and LSON in SYSCR1 and bits DTON and MSON in SYSCR2, TMA3 selects the mode to which transition is made after the SLEEP instruction is executed.



Table 3 Operating Frequency and Waiting Time

Bit				Waiting Time		
STS2	STS1	STS0	Number of Wait States	Operating Frequency: 5 MHz	Operating Frequency: 2 MHz	
0	0	0	8,129 states	1.683 ms	4.1 ms	
0	0	1	16,384 states	3.277 ms	8.2 ms	
0	1	0	1,024 states	0.205 ms	0.521 ms	
0	1	1	2,048 states	0.410 ms	1.024 ms	
1	0	0	4,096 states	0.819 ms	2.048 ms	
1	0	1	2 states (external clock input)	0.0004 ms	0.001 ms	
1	1	0	8 states	0.002 ms	0.004 ms	
1	1	1	16 states	0.003 ms	0.008 ms	

Note: When an external clock is input, bits STS2 to STS0 should be set to the external clock input mode before mode transition is executed. These bits should not be set to the external clock input mode if an external clock is not used.

• SYSCR2 System control register 2 Address: H'FFF1

Bit	Bit Name	Set Value	R/W	Description
3	DTON	0	R/W	Direct transfer on flag
				Selects the mode to transition to after the SLEEP instruction is executed with bits SSBY, TMA3, and LSON in SYSCR1 and bit MSON in SYSCR2.
2	MSON	User defined	R/W	Medium speed on flag
				This bit selects whether operation continues in the active (high-speed) or the active (medium-speed) mode after the standby mode, the watch mode, or the sleep mode is cleared.
				0: Active (high-speed) mode
				1: Active (medium-speed) mode



Revision Record

	Date	Descript	tion	
Rev.		Page	Summary	
1.00	Mar.18.05	_	First edition issued	



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